

- () Preliminary Specifications (V) Final Specifications

Module	11.6"(11.57") HD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B116XTN04.0 (H/W:0A)
Note (🗭)	LED Backlight with driving circuit design

Customer	Date
Checked & Approved by	Date
Note: This Specification i without notice.	s subject to change

Approved by	Date			
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Record of Revision

Vers	ion and Date	Page	Old description	New Description	Remark
0.1	2012/02/29	All	First Edition for Customer	-	-
0.1	2012/03/15	28	TBD	Update EDID	
0.1	2012/03/27	9	TBD	Update Color / Chromaticity Coodinates	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrosatic breakdown.



2. General Description

B116XTN04.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B116XTN04.0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 °C condition:

Items	Unit	Specifications					
Screen Diagonal	[mm]	293.8					
Active Area	[mm]	256.125 X	256.125 X 144.0				
Pixels H x V		1366x3(RG	B) x 768				
Pixel Pitch	[mm]	0.1875 x 0.	1875				
Pixel Format		R.G.B. Vert	ical Stripe				
Display Mode		Normally W	hite				
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m ²]	200 typ. (5 points average) 170 min. (5 points average)					
Luminance Uniformity		1.25 max. (5 points)				
Contrast Ratio		400 typ					
Response Time	[ms]	8 typ / 16 Max					
Nominal Input Voltage VDD	[Volt]	+3.3 typ.					
Power Consumption	[Watt]	2.9 max. (Include Logic and BLU power)					
Weight	[Grams]	235 max.					
Physical Size			Min.	Тур.	Max.		
Include bracket	[mm]	Length	267.5	268.0	268.5		
	[]	Width	174.0	174.5	175.0		
		Thickness 3.6					
Electrical Interface		1 channel LVDS					
Glass Thickness	[mm]	0.5					
Surface Treatment		Anti-Glare, Hardness 3H Reflection 4.3%					
Support Color		262K colors	s (RGB 6-bi	t)			



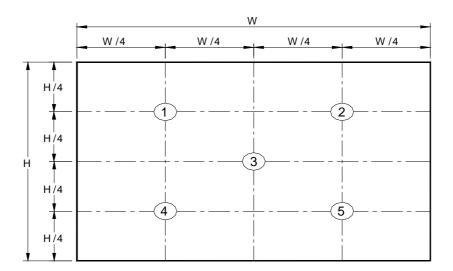
Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

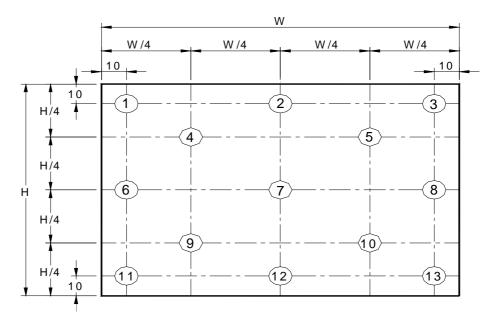
The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

ltem		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance			5 points average	170	200	-	cd/m ²	1, 4, 5.
Viewing Angle		$egin{array}{c} heta_{ extsf{R}} \ heta_{ extsf{L}} \end{array}$	Horizontal (Right) CR = 10 (Left)	40 40	45 45		degree	
viewing Ai	igie	ф н ф ∟	Vertical (Upper) CR = 10 (Lower)	10 30	15 35			4, 9
Luminan Uniformi		δ 5P	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ _{13P}	13 Points	-	-	1.60		2, 3, 4
Contrast R	atio	CR		300	400	-		4, 6
Cross ta	lk	%				4		4, 7
Response 7	Гime	T _{RT}	Rising + Falling	-	8	16	msec	4, 8
	Red	Rx		0.555	0.585	0.615		
	Neu	Ry		0.313	0.343	0.373		
0.1	Green	Gx		0.292	0.322	0.352		
Color / Chromaticity	Oldell	Gy		0.51	0.54	0.57		
Coodinates	Blue	Вх	CIE 1931	0.125	0.155	0.185		4
	Diue	Ву		0.118	0.148	0.178		
	White	Wx		0.283	0.313	0.343		
	vviiite	Wy		0.299	0.329	0.359		
NTSC		%		-	45	-		

Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

6	Maximum Brightness of five points
δ _{W5} =	Minimum Brightness of five points
2 2	Maximum Brightness of thirteen points
$\delta_{W13} =$	Minimum Brightness of thirteen points

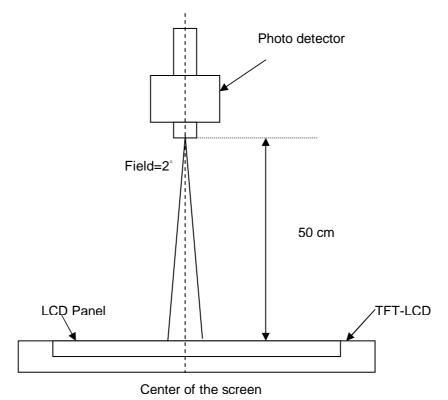
Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, measurement should be executed in the



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center of screen unless otherwise noted.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points , $Y_L = [L (1) + L (2) + L (3) + L (4) + L (5)] / 5 L (x) is corresponding to the luminance of the point X at Figure in Note (1).$

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

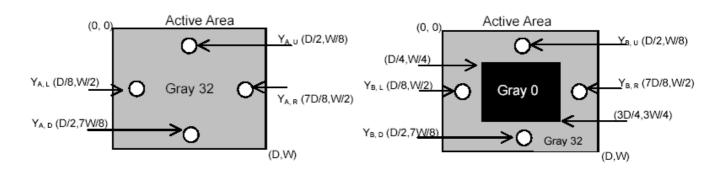
Where

 Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

 Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)

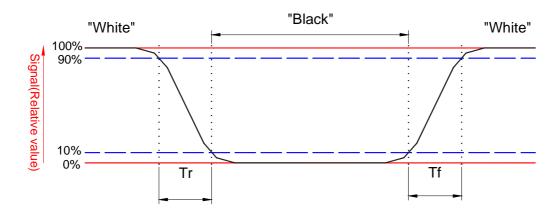


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Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time is interval between the 10% and 90% of amplitudes. Refer to figure as below.

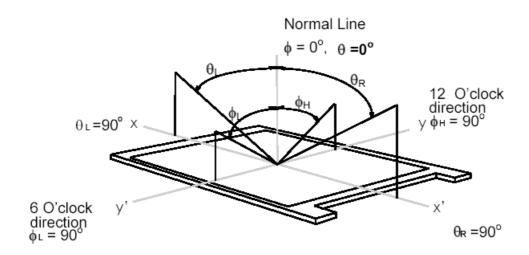




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Note 9. Definition of viewing angle

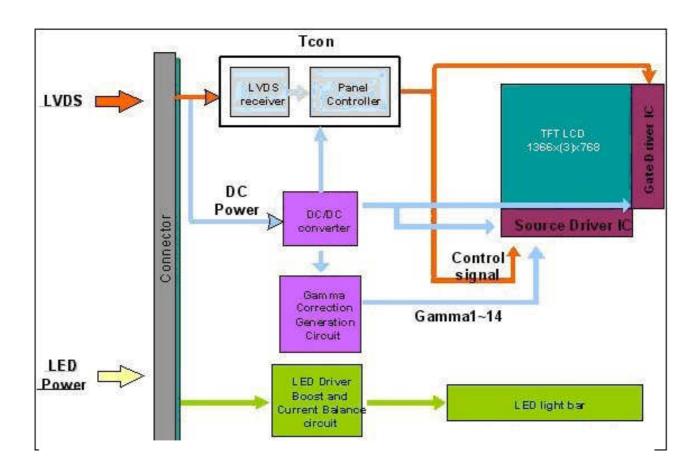
Viewing angle is the measurement of contrast ratio \ge 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 11.6 inches wide Color TFT/LCD 40 Pin one channel Module





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

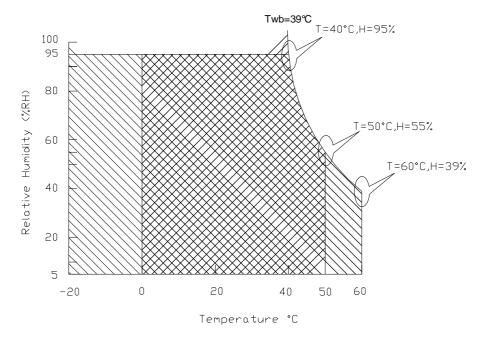
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

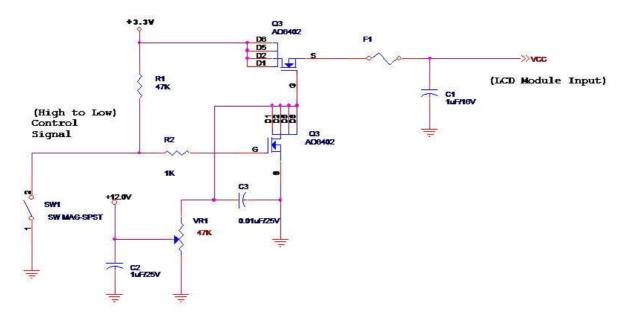
Input power specifications are as follows;

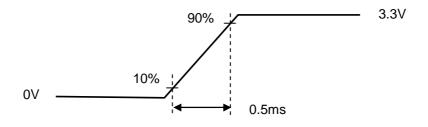
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	_	-	0.8	[Watt]	Note 1
IDD	IDD Current	-	-	242	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (Pmax=V3.3 x Iblack)

Note 2: Measure Condition





Vin rising time



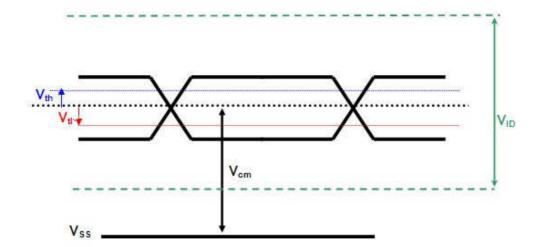
5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{th}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V_{tl}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V _{cm}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform





5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	2.08	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25°C), Note 2 I _F =20 mA

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency, and PLED include driving circuit loss.

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	6.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	Define as
PWM Logic Input High Level		2.5	-	5.5	[Volt]	Connector
PWM Logic Input Low Level	VPWM_EN	-	-	0.8	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	200	1K	10K	Hz	
PWM Duty Ratio	Duty	5		100	%	

Note 1: Recommend system pull up/down resistor no bigger than 10kohm

Note 2: If the PWM duty ratio(min) is set between 5% to 1%, the PWM input frequency should be set below 1KHz. The brightness-duty characteristic might not be able to keep in it's linearity if the dimming control is operated in 1% to 5% range.



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		1									13	66
1st Line	R	G	В	R	G	В		R	G	В	R	G B
							1					
												:
		•			•		•		•			•
		•					•					
							•					:
		•					1					:
		ı			•		ı		1			1
768th Line	R	G	В	R	G	В		R	G	В	R	G B



6.2 The Input Data Format

RxCLKIN	
RxIN0	G0 R5 R4 R3 R2 R1 R0
RxIN1	B1 B0 G5 G4 G3 G2 G1
RxIN2	DE VS HS B5 B4 B3 B2

Signal Name	Description	
R5 R4 R3 R2 R1 R0	Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB) Red-pixel Data	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
G5 G4 G3 G2 G1 G0	Green Data 5 (MSB) Green Data 4 Green Data 3 Green Data 2 Green Data 1 Green Data 0 (LSB) Green-pixel Data	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB) Blue-pixel Data	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	STM MSAK24025P40 or compatible
Mating Housing/Part Number	IPEX 20453-040T-11 or compatible

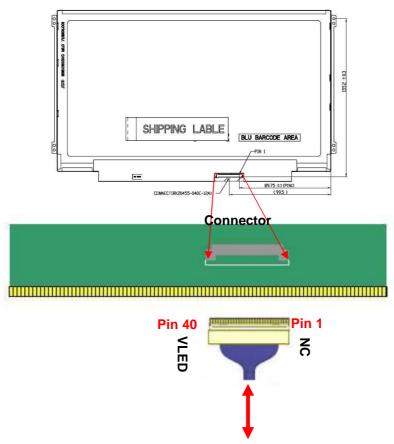
6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Signal Name	Description
1	NC	No Connection (Reserve)
2	VDD	Power Supply +3.3V
3	VDD	Power Supply +3.3V
4	VEDID	EDID +3.3V Power
5	NC	No Connect (Reserve)
6	CLK_EDID	EDID Clock Input
7	DAT_EDID	EDID Data Input
8	RxOIN0-	-LVDS Differential Data INPUT(Odd R0-R5,G0)
9	RxOIN0+	+LVDS Differential Data INPUT(Odd R0-R5,G0)
10	VSS	Ground
11	RxOIN1-	-LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
12	RxOIN1+	+LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
13	VSS	Ground
14	RxOIN2-	-LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
15	RxOIN2+	+LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
16	VSS	Ground
17	RxOCKIN-	-LVDS Odd Differential Clock INPUT
18	RxOCKIN+	-LVDS Odd Differential Clock INPUT
19	NC	Color Matrix Enable (3.0V~3.6V, 3.3V type)
20	NC	No connection
21	NC	No connection
22	NC	No connection



23	NC	No connection
24	NC	No connection
25	NC	No connection
26	NC	No connection
27	NC	No connection
28	NC	No connection
29	NC	No connection
30	NC	No connection
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	VPWM_EN	PWM logic input level
36	VLED_EN	LED enable input level
37	NC	No connection (Disable)
38	VLED	LED Power Supply
39	VLED	LED Power Supply
40	VLED	LED Power Supply



Note1: Input signals shall be low or High-impedance state when VDD is off.



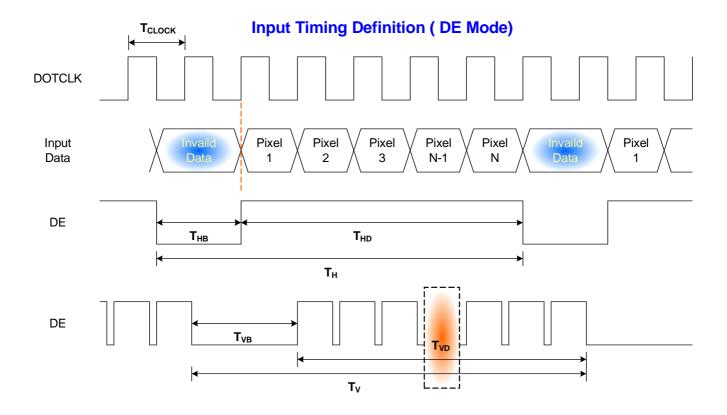
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6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parar	neter	Symbol	Min.	Тур.	Max.	Unit
Frame	Rate	-		60	-	Hz
Clock fro	equency	1/ T _{Clock}	66.4	69.3	80	MHz
	Period	T_{\lor}	776	793	1000	
Vertical	Active	T _{VD}	T _{VD} 768			T_{Line}
Section	Blanking	T _{VB}	8	25	180	
	Period	T _H	1426	1456	2000	
Horizontal Section	Active	T _{HD}		1366		T _{Clock}
	Blanking	T HB	60	90	634	

6.4.2 Timing diagram

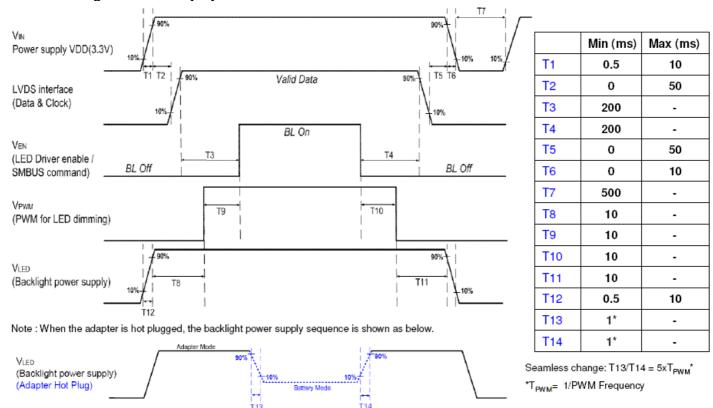




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6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Note 1: If T3<200ms, the display garbage may occur. (T3>200ms is recommended)

Note 2: If T1 or T12<0.5ms, the inrush current may cause the damage of fuse. If T1 or T12<0.5ms, the inrush current I^2 t is under typical melt of fuse Spec, there is no mentioned problem.



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7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

30 Minutes each Axis (X, Y, Z) Sweep:

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

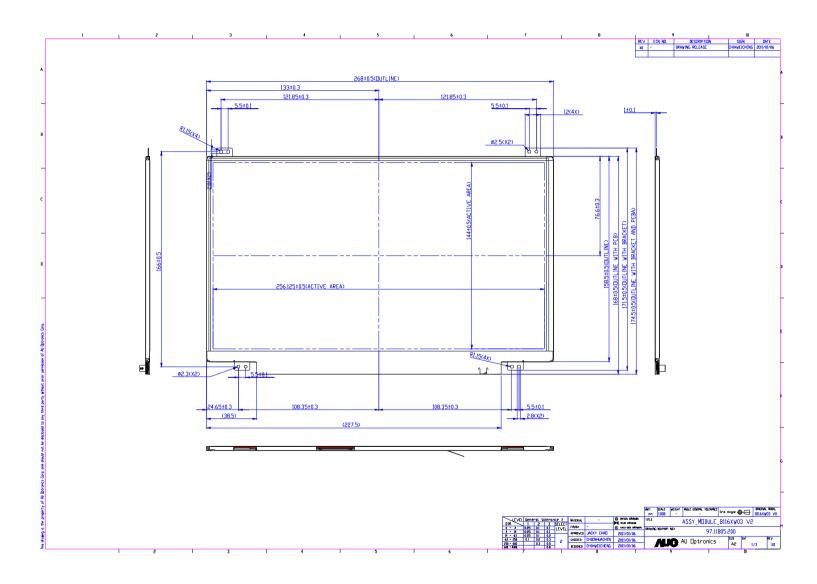
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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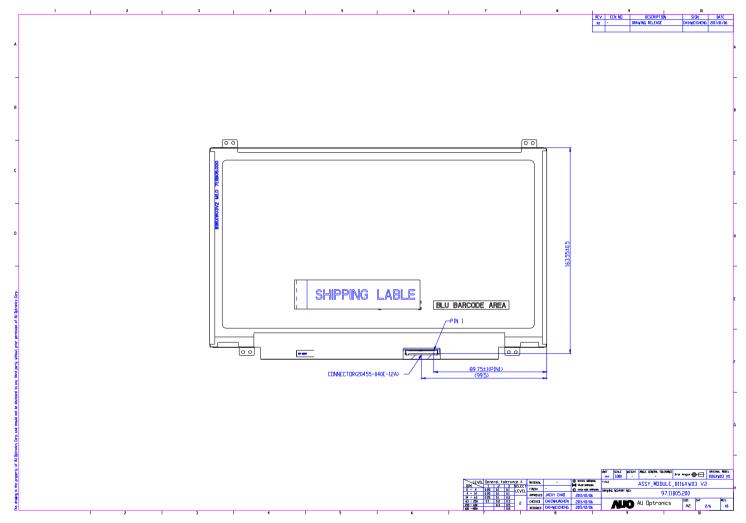
8. Mechanical Characteristics

8.1 LCM Outline Dimension





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Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

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- 9. Shipping and Package
- 9.1 Shipping Label Format

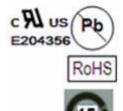
[Z40]



Manufactured MM/WW
Model No: **B116XTN04.0**AU Optronics

H/W: 0A F/W:1

Made in China (Z40)

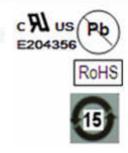


[Z30]



Manufactured MM/WWV
Model No: B116XTN04.0
AU Optronics
Made in China (Z30)

H/W: 0A F/W:1



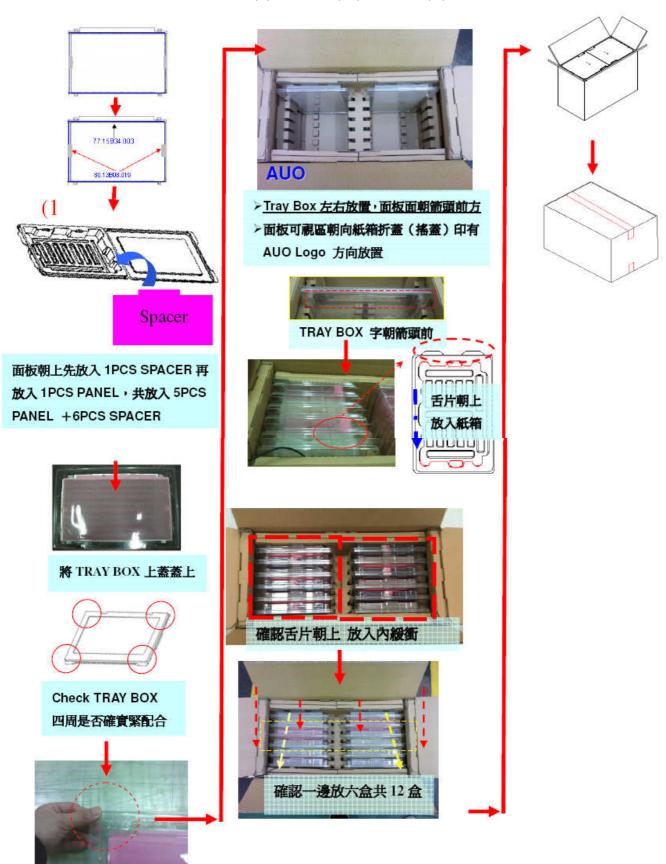
Note: Z40/Z30 is different from Module MFG



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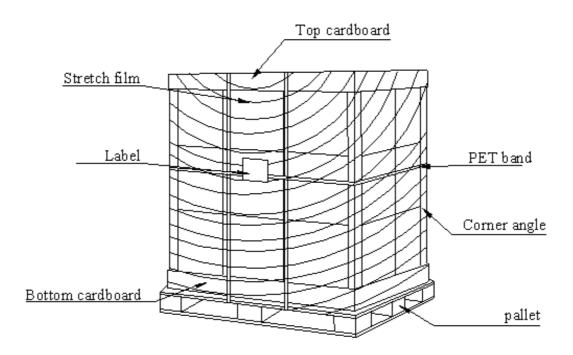
9.2 Carton Package

The outside dimension of carton is 553(L)mm* 275(W)mm* 379(H)mm





9.3 Shipping Package of Palletizing Sequence



9.4 Handling guide

This is a thin and slime LCD model, and please be cautious when pulling it out of package or assembling it onto platform. Careless handlings, e.g. twist, bending, pressing, or collision, will result malfunction of LCD models.

(1) Handling method notice



Do not lift and hold the panel with single hand at right or left side from tray.



Lift and hold the panel up with both hands from tray.



(2) On the table notice



Do not press edge of panel to avoid glass broken.



Do not press the surface of the panel to avoid the glass broken or polarizer scratch.

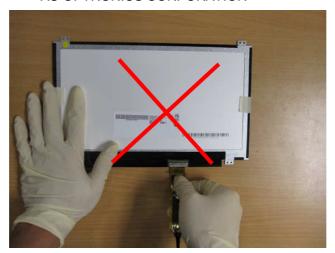




Do not put anything or tool on the panel to avoid the glass broken or polarizer scratch.

(3) Cable assembly notice





Do not insert the connector with single hand and touching the PCBA.



Insert the connector by pushing right and left edge.

10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	



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08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	5C	01011100	92	
0B	hex, LSB first	40	01000000	64	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	16	00010110	22	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	90	10010000	144	
15	Max H image size (rounded to cm)	1A	00011010	26	
16	Max V image size (rounded to cm)	0E	00001110	14	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	99	10011001	153	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	85	10000101	133	
1B	Red x (Upper 8 bits)	95	10010101	149	
1C	Red y/ highER 8 bits	55	01010101	85	
1D	Green x	56	01010110	86	
1E	Green y	92	10010010	146	
1F	Blue x	28	00101000	40	
20	Blue y	22	00100010	34	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	0000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	0000001	1	
25		UI			
2E	Standard timing #5	01	0000001	1	
2F	Standard timing #5		00000001 00000001	1	
	Standard timing #5 Standard timing #6	01			



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32	Standard timing #7	01	0000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	12	00010010	18	
37	Pixel Clock/10000 USB	1B	00011011	27	
38	Horz active Lower 8bits	56	01010110	86	
39	Horz blanking Lower 8bits	5A	01011010	90	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	00	00000000	0	
3C	Vertical Blanking Lower 8bits	19	00011001	25	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00110000	48	
3E	HorzSync. Offset	30	00110000	48	
3F	HorzSync.Width	20	00100000	32	
40	VertSync.Offset : VertSync.Width	36	00110110	54	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	00	00000000	0	
43	Vertical Image Size Lower 8bits	90	10010000	144	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	



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5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	
60	Manufacture	55	01010101	85	
61	Manufacture	4F	01001111	79	
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	
72	Manufacture P/N	31	00110001	49	
73	Manufacture P/N	31	00110001	49	
74	Manufacture P/N	36	00110110	54	
75	Manufacture P/N	58	01011000	88	
76	Manufacture P/N	54	01010100	84	
77	Manufacture P/N	4E	01001110	78	
78	Manufacture P/N	30	00110000	48	
79	Manufacture P/N	34	00110100	52	
7A	Manufacture P/N	2E	00101110	46	
7B	Manufacture P/N	30	00110000	48	
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	СС	11001100	204	